



# SMT GaAs HBT MMIC DIVIDE-BY-2, DC - 8 GHz

### Typical Applications

Prescaler for DC to C Band PLL Applications:

- UNII, Point-to-Point & VSAT Radios
- 802.11a & HiperLAN WLAN
- Fiber Optic
- Cellular / 3G Infrastructure

#### **Features**

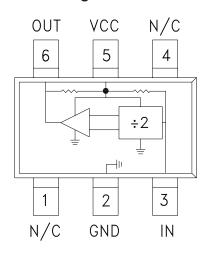
Ultra Low SSB Phase Noise: -148 dBc/Hz

Single-Ended I/O's

Output Power: -3 to -9 dBm

Single DC Supply: +3V @ 42 mA 9 mm² Ultra Small Package: SOT26

### **Functional Diagram**



### **General Description**

The HMC432(E) is a low noise Divide-by-2 Static Divider utilizing InGaP GaAs HBT technology in ultra small surface mount SOT26 plastic packages. This device operates from DC (with a square wave input) to 8 GHz input frequency with a single +3V DC supply. Single-ended inputs and outputs reduce component count and cost. The low additive SSB phase noise of -148 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance.

# Electrical Specifications, $T_A = +25^{\circ}$ C, 50 Ohm System, Vcc= +3V

Parameter	Conditions	Min.	Тур.	Max.	Units
Maximum Input Frequency		8	8.5		GHz
Minimum Input Frequency	Sine Wave Input. [1]		0.2		GHz
Input Power Range	Fin= 1 to 7 GHz Fin= 7 to 8 GHz	-12 -4		+12 +10	dBm
Output Power	Fin= 4 GHz Fin= 8 GHz	-6 -12	-3 -9		dBm dBm
Reverse Leakage	RF Output Terminated, Fin= 4 GHz, Pin= 0 dBm		-30		dBm
SSB Phase Noise (100 kHz offset)	Pin= 0 dBm, Fin= 4 GHz		-148		dBc/Hz
Output Transition Time	Pin= 0 dBm, Fout= 882 MHz		145		ps
Supply Current (Icc)	Vcc= 3.0 V		42	56	mA

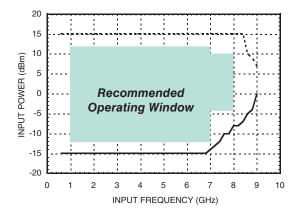
<sup>1.</sup> Divider will operate down to DC for square-wave input signal.



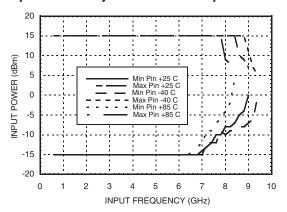


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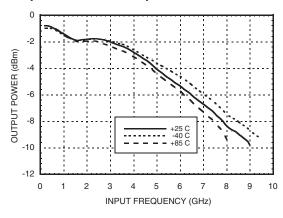
#### Input Sensitivity Window, T= 25 °C



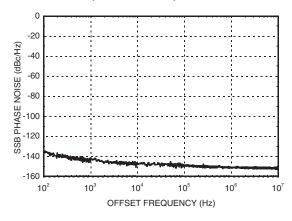
#### Input Sensitivity Window vs. Temperature



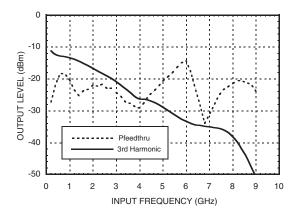
#### **Output Power vs. Temperature**



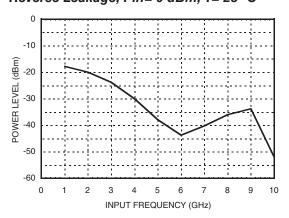
SSB Phase Noise Performance, Pin= 0 dBm, T= 25 °C



### Output Harmonic Content, Pin= 0 dBm, T= 25 °C



### Reverse Leakage, Pin= 0 dBm, T= 25 °C

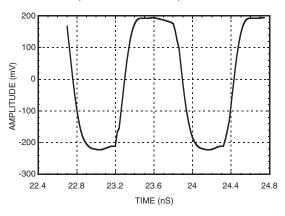






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#### Output Voltage Waveform, Pin= 0 dBm, Fout= 882 MHz, T= 25 °C



### **Absolute Maximum Ratings**

RF Input Power (Vcc = +3V)	15 dBm	
Nominal +3V Supply to GND	-0.3V to 3.5V	
Max Peak Flow Temperature	260 °C	
Storage Temperature	-65 to +125 °C	
ESD Sensitivity (HBM)	150 V	

DC blocking capacitors are required at RF input and RF output ports. Choose value for lowest frequency of operation.



### Reliability Information

Junction Temperature to Maintain 1 Million Hour MTTF	135 °C	
Nominal Junction Temperature (T = 85 °C)	99 °C	
Thermal Resistance (Junction to GND Paddle, 3V Supply)	108 °C/W	
Operating Temperature	-40 to +85 °C	

#### Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
2.70	34
3.00	42
3.30	50

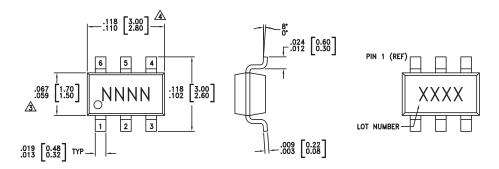
Note: Divider will operate over full voltage range shown above

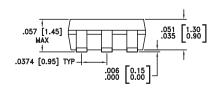




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## **Outline Drawing**





#### NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

  DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC432	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H432 XXXX
HMC432E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	432E XXXX

- [1] Max peak reflow temperature of 235  $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

### Pin Description

Pin Number	Function	Description	Interface Schematic	
1, 4	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.		
2	GND	Pin must connect to RF/DC ground.	○ GND —	
3	IN	RF input must be DC blocked.	Vcc 3V 50n	



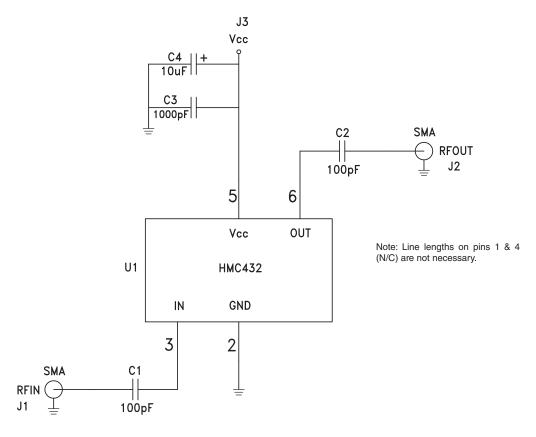


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### Pin Description (Continued)

Pin Number	Function	Description	Interface Schematic	
5	Vcc	Supply voltage 3V ± 0.3V.	Vcc Ο 8pF 71Ω	
6	ОИТ	Divided output must be DC blocked.	50n OUT	

# **Application Circuit**



Note:

DC blocking capacitor values (C1, C2) and DC decoupling capacitor values (C3, C4) are chosen for lowest frequency of operation.